

TRI-STATE GENERATION AND TRANSMISSION

Scholarship Program Scholarship Submittal Requirements

Complete this form by typing or printing (attach additional sheets if necessary).

Enclose your most recent high school academic transcript.

Accompanying your transcripts, the following must be included to constitute a completed application package:

- ✓ *A copy of your college entrance examination (ACT and/or SAT) scores.*
- ✓ *A 500-word essay outlining your future career goals.*
- ✓ *A copy of your high school honors, extracurricular activities and community service.*
- ✓ *One (or more) letter(s) of reference from a teacher, counselor, employer, or system manager.*
- ✓ *If selected, you will be requested to submit a senior photo for marketing purposes. The photo will need to be a high resolution jpeg and emailed to jbennett@lpea.coop. Preference would be a head & shoulders photo of applicant.*

**APPLICATIONS WILL NOT BE CONSIDERED UNLESS ALL OF THE ABOVE
REQUIRED INFORMATION IS INCLUDED IN THE SCHOLARSHIP APPLICATION
PACKAGE.**

Application deadline is March 1, 2017

All completed application packets should be mailed or hand delivered to:

***Jeannie Bennett, Public Relations Coordinator
La Plata Electric Association, Inc. (LPEA)
PO Box 2750
Durango, CO 81302
Office Location:
45 Stewart Street (Bodo Park) in Durango
603 S. 8th Street in Pagosa Springs***

***Applications being hand delivered are due by 5:00 pm on March 1, 2017.
Applications being mailed must be postmarked on March 1, 2017.***

All Scholarship Applications are Confidential.

11. GPA? _____

SCHOLARSHIP PROGRAM APPLICATION

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12. Are you a U.S. Citizen? _____ Yes _____ No

13. Goals and Aspirations (Write a 500 word essay about your academic plans as they relate to your educational and career objectives and long-term goals).

****Please attach a separate sheet with this information.***

Student's Signature

Date

Parent's Signature

Date

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